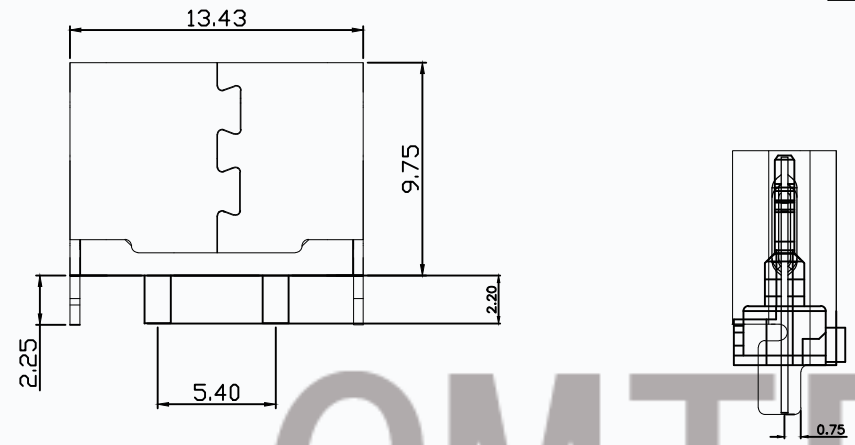


REV.	MODIFICATION	ECN No.	NAME	DATE
A0	新版发行		ERIC	2016-06-18



- NOTES:
- MATERIAL:
MOLDING: LCP UL94 V-0
CONTACT: COPPER ALLOY.
GOLD PLATED Min ON CONTACT AREA, 100u"
Min TIN (LEAD FREE) ON SOLDER AREA,
SHELL: SUS304-H, T=0.30±0.03mm
50u" NICKEL PLATING OVER ALL.
 - MECHANICAL:
INSERTION: 5~20N.
EXTRACTION: 8~20N AFTER TEST.
DURABILITY: 10000 CYCLES
 - ELECTRICAL:
CURRENT: 3A FOR VBUS;
1.25A FOR GND PIN.
0.25A FOR OTHER.
VOLTAGE: 20 V MAX
WITHSTANDING VOLTAGE: 100V AC R.M.S.
CONTACT RESISTANCE: 40mΩ MAX.
INSULATION RESISTANCE: 100MΩ MIN.
 - ENVIRONMENTAL
TEMPERATURE RANGE -25°C ~ +85°C
 - 尺寸标注事项:
图示有标示"XX"者为首样全检, 重点管控尺寸
 - 产品符合RoHS标准

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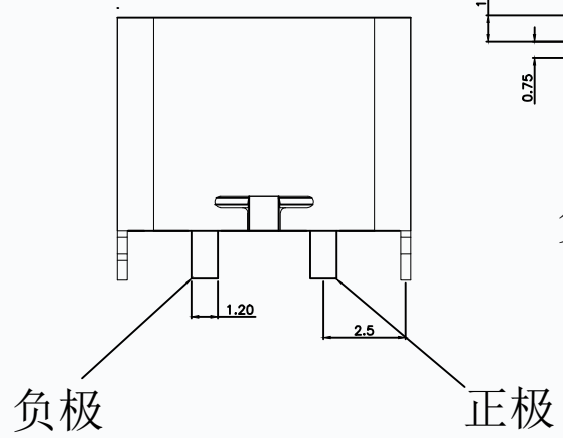
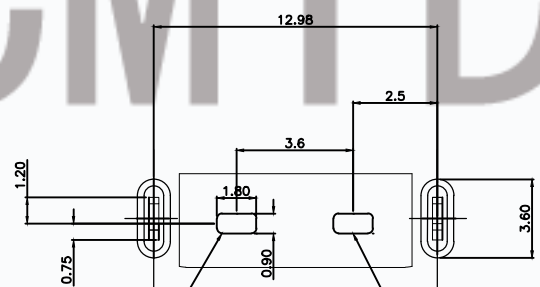


Table:

成品料号	零件名称	零件料号	材料 / 电镀
TX	端子	TX	SUS 304 R-H NO PLATING
	端子	TX	SUS 301 R-H Sn 80~200u"
	外壳	TX	SUS 301 R-H 电镀切料带后.

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DONGGUAN TIANDU TECHNOLOGY CO., LTD.

.X: ±0.35	.X': ±1.5'	INTENDED USE:	TITLE:
.XX: ±0.25	.XX': ±1.0'	CONNECTOR	TYPE-C 2P 直插母座
.XXX: ±0.20	.XXX': ±0.5'	APPD.:	PART NO.: SEE TABLE
MAT'L.: SEE NOTES		CHKD.:	DWG. NO.: T11-02LC01-9.75H
FINISH:		DR.: ERIC	SCALE: 1:1 PAGE: 1/1
			UNIT: mm REV.: A0